案件編號Case No：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_

附件一

元智大學研發成果技術媒合申請書

YZU R&D Results Matchmaking Application Form

填表日期Date Completed：\_\_\_\_\_年(Y)\_\_\_\_月(M)\_\_\_\_日(D)

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| 基本資料Basic Information |
| 成果（技術）發明申請人Inventor of the Result |  |
| 服務機關及單位Service Agency and Unit |  |
| 職稱Title |  |
| 聯絡電話Phone |  |
| 電子郵件Email |  |
| 傳真Fax |  |
| 通訊地址Correspondence Address |  |
| 永久地址Permanent Address |  |
| 其它成果（技術）發明人Additional Inventors of the Result (Technology)（多位發明人時，請須填寫此欄位）(Complete this section if there are multiple inventors) |  |

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| 技術資料Technical Data |
| 技術名稱Technology Name | （中文Chinese） |
| （英文English） |
| 技術分類Technology Category | 所屬領域別Field：□理Science □工Engineering □醫Medical □農Agriculture技術性質Nature of Technology：□新產品技術New Product Technology□產品改良技術Public Works Technology□公共工程技術Product Improvement Technology□新製程技術New Process Technology□製程改良技術Process Improvement Technology□管理控制技術Management Control Technology |
| 智慧財產權類別Intellectual Property Type | □專門技術知識know-how□專利權Patent Rights：□發明專利Invention Patent，已核准國家Approved by Country\_\_\_\_\_\_No.\_\_\_\_\_\_\_\_\_\_；審查中國家Under Review by Country\_\_\_\_\_\_\_\_\_□新型專利Utility Model Patent，已核准國家Approved by Country\_\_\_\_\_\_\_\_\_No.\_\_\_\_\_\_\_\_\_\_；審查中國家Under Review by Country\_\_\_\_\_\_\_\_□申請中Pending Application |
| 本成果（技術）產出來源Source of the Result (Technology) | 1.成果（技術）產出Origin of the Result (Technology)：□自行研發Self-developed□國科會計畫產出NSTC（□產學合作Industry–Academia□專題研究Research Project）□其他委託計畫Others2.成果（技術）所有權歸屬Ownership of the Result (Technology)：□元智大學YZU\_\_\_\_\_% □計畫出資單位Project Funding Agency\_\_\_\_\_% □其他Others\_\_\_\_\_%3.計畫名稱Project Title：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_（自行研發免填Not applicable for self-developed）4.計畫編號Project No：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_5.計畫經費Project Budget NT$：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_6.資助機關及合作廠商Funding Agencies and Collaborating Manufacturers：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_7.出資比例Contribution Ratio：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_  |
| 技術內容Technical Description | （非機密性的技術內容描述，以供公告、公開之用途）（Non-confidential description of the technology for announcement and public disclosure purposes） |
| （機密性的技術內容描述）（選填）(Confidential description of the technology—optional) |
| 技術創新程度Degree of Technological Innovation | □全新技術Entirely New Technology：□國內全新技術，國外已有類似技術Similar new domestic technology exists abroad \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_□世界性全新技術World’s first technology\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_□改良技術Improved Technology：現有技術分析Existing technology analysis：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_改良技術成效Effectiveness of the improvements：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ |
| 技術成熟度Technology Maturity | □概念形成及分析Concept Formation and Analysis□技術研究開發(已針對現有技術，至少可界定三項改良之差異性)Technology Research and Development (has defined at least three areas of improvements over existing technologies)□已具備工程雛型（已鑑定量產及市場障礙，並進行對策分析）Engineering Prototype Available (production and market barriers identified with countermeasures analyzed) |
| 國內廠商之接受度Acceptance by Domestic Manufacturer | □已具備足夠能力承接，應有技術移轉之興趣Capable and interested in technology transfer□有能力承接，但市場尚小Capable but the market is limited |
| 技術市場性Market Viability of the Technology | 1.技術使用市場Technology User Market：□國內目前可承接技術廠商家數（約）\_\_\_\_\_\_\_\_\_\_\_\_\_家Current domestic capable technology manufacturers (approx.) \_\_\_\_\_\_\_\_\_\_\_\_\_companies未來可利用廠商家數（約)\_\_\_\_\_\_\_\_\_\_\_\_家Future potential manufacturers (approx.)\_\_\_\_\_\_\_\_\_\_\_\_\_\_companies□國外廠商為主Primarily foreign manufacturers2.產品市場Product Market：國內市場年產值（約）Annual domestic market value (approx.) NT$\_\_\_\_\_\_\_\_\_\_\_國外市場年產值（約）Annual foreign market value (approx.) NT$\_\_\_\_\_\_\_\_\_\_\_ |
| 預期利用範圍及預期產品Expected Scope of Use and Anticipated Products |  |
| 技術移轉後續工作預估分析Analysis of Follow-up Work After Technology Transfer | （約\_\_\_\_年後可有產品上市或達成預期效果）(Estimated years until product launch or expected outcomes are achieved) |
| 建議授權方式Recommended Licensing Method | □非專屬授權(國內合格廠商皆可獲得授權，建議本次最多移轉\_\_\_\_\_\_\_\_\_家)Non-exclusive licensing (available to all qualified domestic manufacturers, recommended transfer to up to \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ companies)□專屬授權Exclusive licensing(理由Reason：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_) |
| 遴選廠商資格建議Recommendations for Manufacturer Selection | 1.產業類別Industry Category：2.應具備之專門技術Industry Category：3.應有之機具設備Necessary Equipment：4.應有之研究或技術人員人數Required Number of Research or Technical Personnel：5.其他條件Other Conditions： |
| 推薦廠商Recommended Manufacturers | 廠商名稱Manufacturer 聯絡人Contact Person 聯絡電話Phone 聯絡地址Contact Address\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_ \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ |
| 建議通知相關團體Suggested Notifications to Relevant Groups | (如相關公會、協會、研究機構等e.g., related guilds, associations, research institutions) |
| 技術作價Technology Valuation | 1.權利金（技術使用費）Licensing Fee (Technology Usage Fee)：NT$\_\_\_\_\_\_\_\_\_\_\_2.衍生利益金百分比Percentage of Derived Benefits：\_\_\_\_\_\_% |
| 權利金收取方式之建議Recommendations for Licensing Fee Collection Method | □二階段收取：簽約時收權利金，產品上市後收衍生利益金Two-stage collection: Collect licensing fee at signing, collect derived benefits upon product launch.□一次收取：權利金與衍生利益金於簽約時一次收取One-off collection: Collect both licensing fee and derived benefits at signing.(理由Reason：\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_) |
| 成果（技術）發明申請人（簽章）Inventor of the Result (Technology)（Signature） | 其它成果（技術）發明人（簽章）Additional Inventors of the Result (Technology)（Signature） |
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